Type CRGP Series

Key Features

Small size and light weight

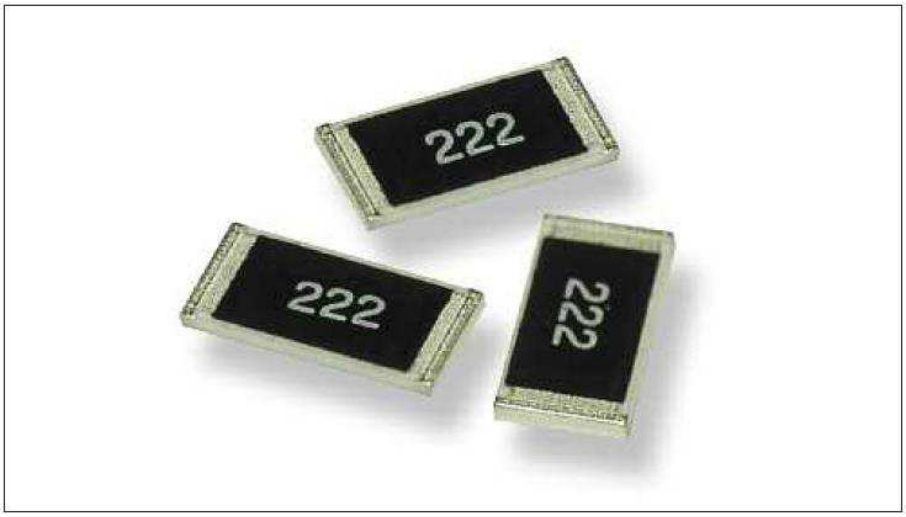
Suitable for both wave and reflow soldering techniques

Supplied on tape

Pulse Rated

7 different package sizes

Terminal finish matte Sn over Ni



TE Connectivity is pleased to introduce this SMD Pulse withstand thick film Chip resistor, suitable for auto placement in volume and for most applications. Available in five different packages and supplied on tape and reel for automatic insertion processes. Standard values – E24 Series

Characteristics – Electrical

Type	CRGP0402	CRGP0603	CRGP0805	CRGP1206
Power Rating @ 70°C	0.125W	0.25W	0.33W	0.5W
Max. Working Voltage	50V	50V	150V	200V
Max. Overload Voltage	100V	100V	300V	400V
Dielectric Withstand	100V	300V	500V	500V
Temperature Range	-55°C ~ +155°C			
Ambient Temperature	70°C			

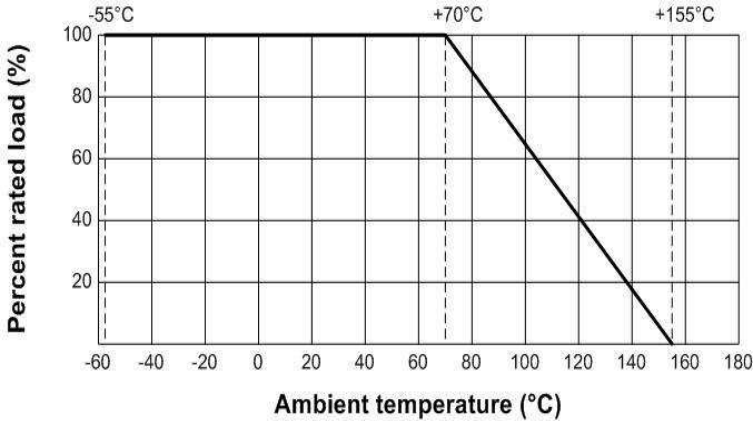
Type	CRGP1210	CRGP2010	CRGP2512
Power Rating @ 70°C	0.75W	1.25W	2W
Max. Working Voltage	200V	400V	500V
Max. Overload Voltage	500V	800V	1000V
Dielectric Withstand	500V	500V	500V
Temperature Range	-55°C ~ +155°C		
Ambient Temperature	70°C		

Dimensions in millimetres unless otherwise specified

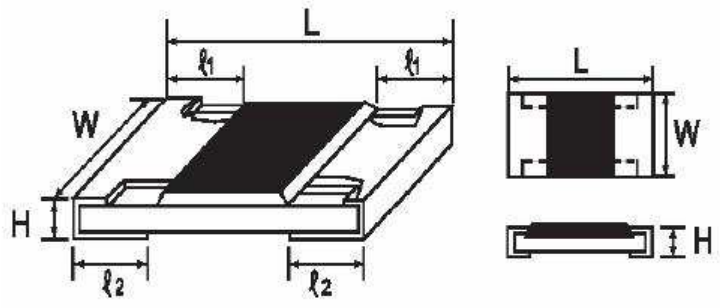
Dimensions Shown for reference purposes only. Specifications subject to change

Power derating curve

Power rating based on continuous load operation in ambient temperature of 70°C. For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with this curve.



Dimensions:

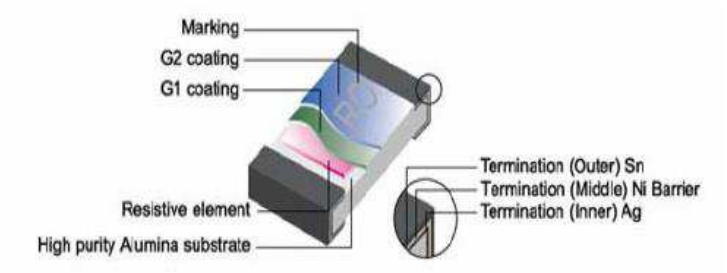


Type	Dimension (mm)				
	L	W	H	ℓ1	ℓ2
CRGP0402	1.10±0.10	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
CRGP0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20
CRGP0805	2.00±0.15	1.25+0.15 -0.10	0.55±0.10	0.40±0.20	0.40±0.20
CRGP1206	3.10±0.15	1.55+0.15 -0.10	0.55±0.10	0.45±0.20	0.45±0.20
CRGP1210	3.10±0.10	2.60±0.20	0.55±0.10	0.55±0.25	0.50±0.20
CRGP2010	5.00±0.10	2.50±0.20	0.55±0.10	0.60±0.25	0.50±0.20
CRGP2512	6.35±0.10	3.20±0.20	0.55±0.10	0.60±0.25	0.50±0.20

Dimensions in millimetres unless otherwise specified

Dimensions Shown for reference purposes only. Specifications subject to change

Construction:



Power Rating and Resistance Range:

Type	Power Rating @ 70°C	Tolerance	Resistance Range	Standard Series
CRGP0402	0.125W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation
CRGP0603	0.25W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation
CRGP0805	0.33W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation
CRGP1206	0.5W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation
CRGP1210	0.75W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation
CRGP2010	1.25W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation
CRGP2512	2W	±1% ±5%	1R0 – 10M	E24 E96 by negotiation

Marking:

E24 series 0603 – 2512 3 Digits – first two digits denote significant figures of resistance and third digit denotes number of zeros thereafter. EG

	222		=	2K2

Dimensions in millimetres unless otherwise specified

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Marking for E96 Series 0805 – 2512 4 digits – First three digits denote significant figures of resistance and fourth digit denotes number of zeros thereafter. EG.

	1000		=	100R

For ohmic values below 100R letter “R” denotes decimal point. EG

	1R80		=	1R8 / 1.8Ω

0402 size chips are not marked

0603 E96 3 digit marking.

Mutiplier Code :

Code	A	B	C	D	E	F	G	H	X	Y	Z
Multiplier	0 10	1 10	2 10	3 10	4 10	5 10	6 10	7 10	-1 10	-2 10	-3 10

Coding

XX

Resistance Code

Formula

X

Multiplier Code

Example : 10.2KΩ = 102 X 10 Ω = 02C (02 ↓, C ↓)

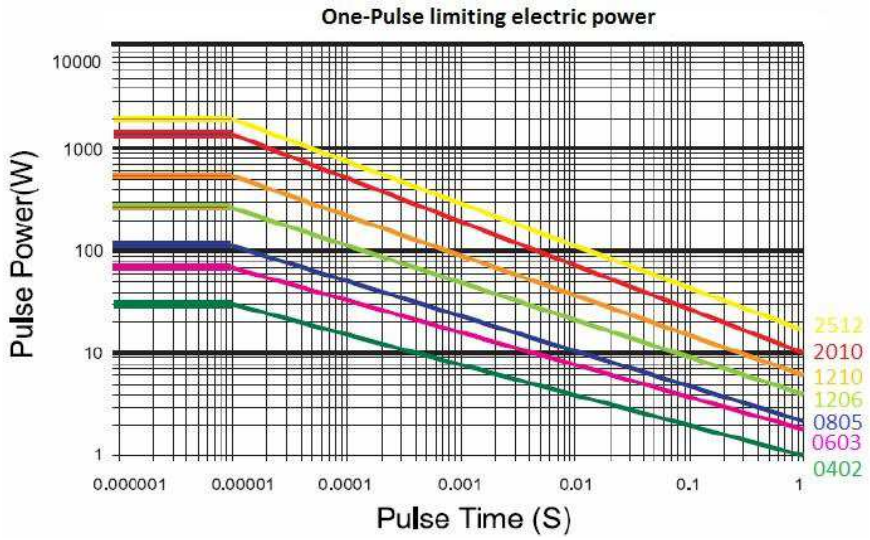
33.2Ω = 332 X 10^{-1} Ω = 51X (51 ↓, X ↓)

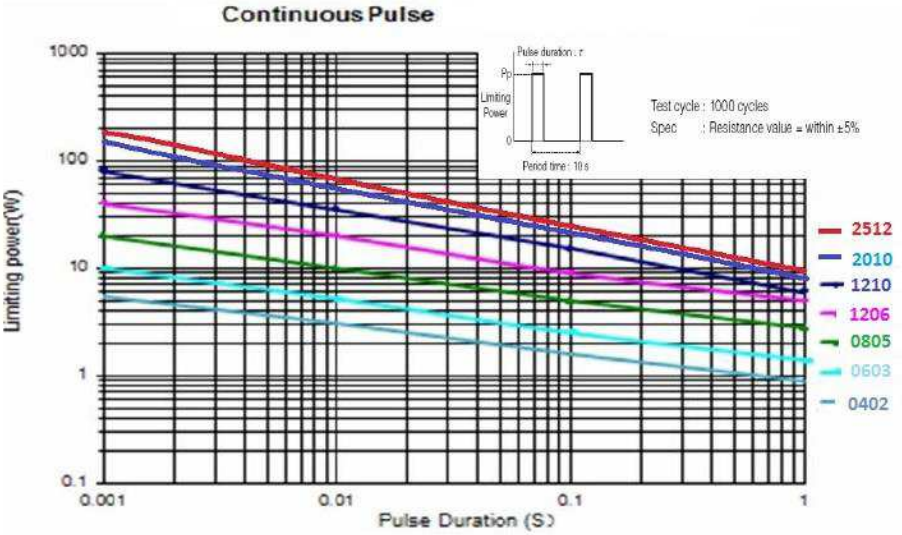
Value	Code	Value	Code	Value	Code	Value	Code	Value	Code
100	01	162	21	261	41	422	61	681	81
102	02	165	22	267	42	432	62	698	82
105	03	169	23	274	43	442	63	715	83
107	04	174	24	280	44	453	64	732	84
110	05	178	25	287	45	464	65	750	85
113	06	182	26	294	46	475	66	768	86
115	07	187	27	301	47	487	67	787	87
118	08	191	28	309	48	499	68	806	88
121	09	196	29	316	49	511	69	825	89
124	10	200	30	324	50	523	70	845	90
127	11	205	31	332	51	536	71	866	91
130	12	210	32	340	52	549	72	887	92
133	13	215	33	348	53	562	73	909	93
137	14	221	34	357	54	576	74	931	94
140	15	226	35	365	55	590	75	953	95
143	16	232	36	374	56	604	76	976	96
147	17	237	37	383	57	619	77		
150	18	243	38	392	58	634	78		
154	19	249	39	402	59	649	79		
158	20	255	40	412	60	665	80		

- Marking for E96 series 0603 size with no marking code marked as per E24 values.

Pulse withstand capacity

The single impulse graph is the result of 50 impulses of rectangular shape applied at one-minute intervals. The limit of acceptance was a shift in resistance of less than 1% from the initial value. The power applied was subject to the restrictions of the maximum permissible impulse voltage graph shown.



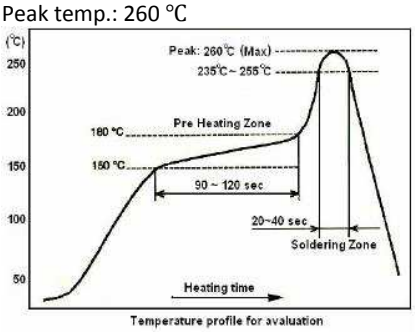


Dimensions in millimetres unless otherwise specified

Dimensions Shown for reference purposes only. Specifications subject to change

For Email, phone or live chat, go to: www.te.com/help

Performance Specification:

Characteristic	Limits	Test Methods (JIS C 5201-1)
Temperature Coefficient	±100PPM/°C *0402: 1Ω-10Ω : ± 400 PPM/°C 11Ω-100Ω : ± 200 PPM/°C >100Ω : ± 100 PPM/°C	Natural resistance change per temp. degree centigrade R1-R2 --------- x10⁶ (PPM/°C) R1(t2-t1) R1 resistance value at room temperature (t1) R2 Resistance value at room temperature +100°C (t2) (Sub-clause 4.8)
Short term overload	Resistance change rate is ±5% : ±(2.0% ±0.1Ω) Max. ±1% : ±(1.0% ±0.1Ω) Max.	Permanent resistance change after the application of a potential of 2.5 times RCWV for 5 seconds Sub-clause 4.13
Terminal Bending	± (1.0% ±0.05Ω) Max.	Twist of Test Board : Y/X = 5/90 mm for 10 seconds (Sub-clause 4.33)
Insulation Resistance	1,000MΩ or more	Apply 500V DC between protective coating and termination for 1 min, then measure (Sub-clause 5.6)
Dielectric Withstand Voltage	No evidence of flashover, mechanical damage, arcing or insulation breakdown.	Apply 500V AC between protective coating and termination for 1 minute (Sub-clause 4.7)
Soldering Heat	Resistance change rate is ±(1.0%+0.05Ω) Max.	Dip the resistor into a solder bath having a temperature of 260°C±3°C and hold it for 10±1 seconds (Sub-clause 4.18)
Solderability	95% coverage Min.	Test temperature of solder : 245 ± 3 °C Dwell time in solder : 2 ~ 3 seconds (Sub-clause 4.17)
Solder Temp. Reference	Electrical characteristics shall be satisfied without distinct deformation in appearance. (95% coverage Min.)	Wave soldering condition: (2 cycles Max.) Pre-heat : 100 ~ 120 °C, 30 ± 5 sec. Peak temp.: 260 °C Reflow soldering condition: (2 cycles Max.) Pre-heat : 150 ~ 180 °C, 90 ~ 120 sec. Suggestion solder temp.: 235 ~ 255 °C, 20 ~ 40 sec. Peak temp.: 260 °C  Temperature profile for evaluation Hand Soldering 300°C 5 seconds

Dimensions in millimetres unless otherwise specified

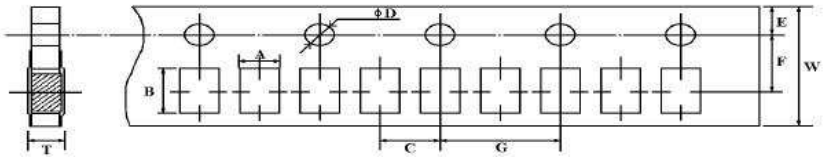
Dimensions Shown for reference purposes only. Specifications subject to change

Performance Specification (continued)

Characteristic	Limits	Test Methods (JIS C 5201-1)		
Temperature Cycling	Resistance change rate is: ±5%: ±(3%±0.1Ω) Max. ±1%: ±(0.5%±0.1Ω) Max.	Resistance change after continuous 5 cycles for duty specified below:		
		Step	Temperature	Time
		1	-55°C±3°C	30 mins.
		2	Room Temp.	10~15 mins.
		3	+155°C±2°C	30 mins.
		4	Room Temp.	10~15 mins.
		(Sub-clause 4.19)		
Humidity	Resistance change rate is: ± (3.0% + 0.1Ω) Max.	Temporary resistance change after 240 hours exposure in a humidity test chamber controlled at 40±2°C and 90-95% relative humidity (Sub-clause 4.24)		
Load Life In Humidity	Resistance change rate is: ±5% : ±(3.0% ±0.1Ω) Max. ±1% : ±(1.0% ±0.1Ω) Max.	Resistance change after 1,000 hours (1.5 hours "on", 0.5 hour "off") at RCWV in a humidity chamber controlled at 40℃ ± 2℃ and 90 to 95 % relative humidity. (Sub-clause 4.24.2.1)		
Load Life	Resistance change rate is: ±5% : ±(3.0% ±0.1Ω) Max. ±1% : ±(1.0% ±0.1Ω) Max.	Permanent resistance change after 1,000 hours operating at RCWV, with duty cycle of (1.5 hours "on", 0.5 hour "off") at 70℃ ± 2℃ ambient (Sub-clause 4.25.1		

Packaging Specification

Paper taping

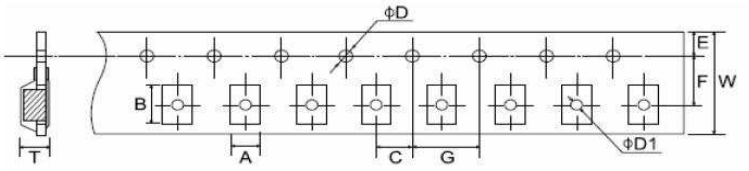


Type	A ± 0.2	B ± 0.2	C ± 0.05	ØD +0.1 -0	E ± 0.1	F ± 0.05	G ± 0.1	W ± 0.2	T ± 0.1
0402	0.65	1.15	2.0	1.5	1.75	3.5	4.0	8.0	0.45
0603	1.10	1.90	2.0	1.5	1.75	3.5	4.0	8.0	0.67
0805	1.65	2.40	2.0	1.5	1.75	3.5	4.0	8.0	0.81
1206	2.00	3.60	2.0	1.5	1.75	3.5	4.0	8.0	0.81
1210	2.80	3.50	2.0	1.5	1.75	3.5	4.0	8.0	0.75

Dimensions in millimetres unless otherwise specified

Dimensions Shown for reference purposes only. Specifications subject to change

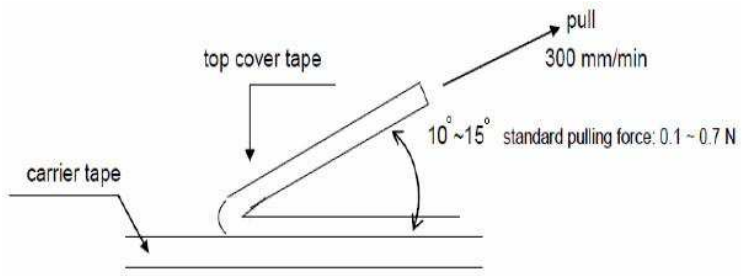
Embossed Taping



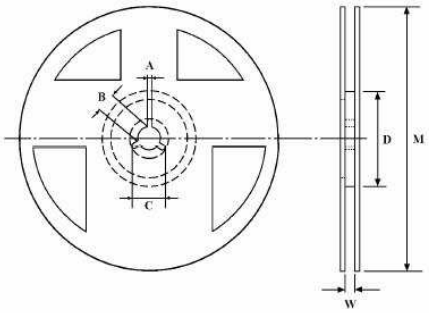
Type	A ±0.2	B ±0.2	C ±0.05	ØD +0.1 -0	ØD1 +0.1 -0	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ± 0.1
2010	2.90	5.60	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0
2512	3.50	6.70	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0

Peeling strength of cover tape:

Test condition: 0.1 to 0.7 N at a peel off speed of 300mm / min.



Reel Dimensions (mm):



Type	Tape	Reel Qty	A ± 0.5	B ± 0.5	C ± 0.5	D ± 1	M ± 2	W ± 1
0402	Paper	10,000	2	13	21	60	178	10
0603	Paper	5,000	2	13	21	60	178	10
0805	Paper	5,000	2	13	21	60	178	10
1206	Paper	5,000	2	13	21	60	178	10
1210	Paper	5,000	2	13	21	60	178	10
2010	Embossed	4,000	2	13	21	60	178	13.8
2512	Embossed	4,000	2	13	21	60	178	13.8

Dimensions in millimetres unless otherwise specified

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Label:

A. TE Product Number
B. Product Description
C. Quantity
D. Lot Number
E. RoHS Statement

Example:

Environment Related Substance

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs), Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

Storage Condition

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of 25°C ± 10°C and a relative humidity of 60%RH ± 10%RH, chemical and dust free atmosphere

Even within the above guarantee periods, do not store these products in the following conditions otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NO2

2. In direct sunlight

Solder Profile

Wave soldering condition: (2 cycles Max.)

Pre-heat : 100 ~ 120 ℃, 30 ± 5 sec.

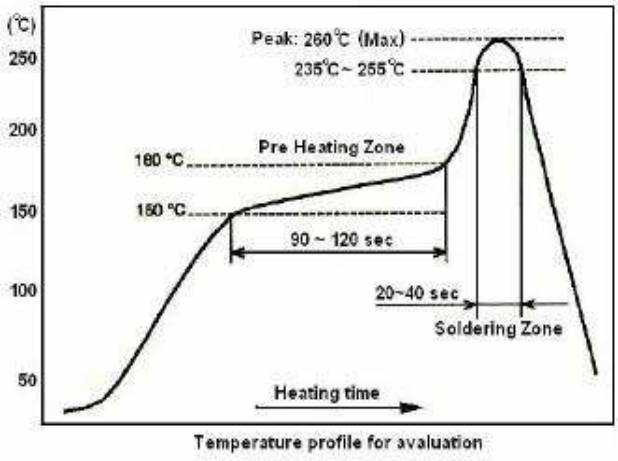
Peak temp.: 260 ℃

Reflow soldering condition: (2 cycles Max.)

Pre-heat : 150 ~ 180 ℃, 90 ~ 120 sec.

Suggestion solder temp.: 235 ~ 255 ℃, 20 ~ 40 sec.

Peak temp.: 260 ℃



Temperature profile for avaluation

Hand Soldering condition: The Soldering iron tip should be less than 300°C and maximum contact time should be 5 seconds

How To Order

CRGP	0603	J	10K
Common Part	Size	Tolerance	Resistance Value
CRGP – Pulse Withstand Thick Film Chip Resistor	0402 0603 0805 1206 1210 2010 2512	F - ±1% J - ±5%	1 ohm (1Ω) 1R0 1K ohm (1000Ω) 1K0 100K ohm (100000Ω) 100K 1M ohm (1000000Ω) 1M0

Dimensions in millimetres unless otherwise specified

Dimensions Shown for reference purposes only. Specifications subject to change

Mouser Electronics

Authorized Distributor

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TE Connectivity:

CRGP1206F68K CRGP0402F5K6 CRGP1206F390R CRGP0805F18K CRGP0402F68K CRGP2512F390R CRGP1210F820R CRGP1206F100R CRGP1206F220K CRGP0603F150K CRGP2010F180R CRGP2512F39R CRGP1206F680R CRGP0603F470R CRGP2010F560R CRGP1210F470R CRGP1206F33R CRGP0402F39K CRGP0402F33R CRGP0402F1K8 CRGP0402F100K CRGP2512F680R CRGP1210F270K CRGP0402F1M0 CRGP0402F1K2 CRGP1206F1K8 CRGP2010F560K CRGP0603F470K CRGP1210F470K CRGP1206F10K CRGP0402F390R CRGP2010F4K7 CRGP2512F470K CRGP2010F10K CRGP0402F560K CRGP2010F82R CRGP1210F15K CRGP1210F220R CRGP2010F1K5 CRGP0603F8K2 CRGP2010F270K CRGP0402F180K CRGP0805F1K8 CRGP2010F27K CRGP1206F56R CRGP2010F5K6 CRGP1210F4K7 CRGP1210F390R CRGP0402F18K CRGP0402F1K0 CRGP1210F560R CRGP0402F3K3 CRGP1210F120K CRGP1206F470R CRGP2512F270K CRGP2010F150R CRGP2512F33R CRGP1206F330K CRGP0603F2K7 CRGP2512F820R CRGP2512F56K CRGP0805F68K CRGP1210F33R CRGP2512F180K CRGP2010F820K CRGP0402F470K CRGP2512F12R CRGP1206F18R CRGP0402F330R CRGP2512F27K CRGP2512F560R CRGP0603F330K CRGP1206F150R CRGP0603F39K CRGP1210F1M0 CRGP0402F15R CRGP0805F15K CRGP0805F33K CRGP1210F68R CRGP0805F390K CRGP0603F33K CRGP2010F220K CRGP1210F1K0 CRGP1206F3K9 CRGP2512F22K CRGP2512F560K CRGP1210F56K CRGP0402F47K CRGP0805F82K CRGP0603F68K CRGP0402F820R CRGP0805F12K CRGP2512F15R CRGP2010F6K8 CRGP0805F10R CRGP0402F82R CRGP1206F47K CRGP0603F3K9 CRGP1206F390K CRGP2010F1K0